



S00P1291US00  
Docket No: S00P1291US00

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

JUN 11 2001

APPLICANT: Hiroyuki Honma  
SERIAL NO: 09/695,623  
FILED: October 24, 2000  
TITLE: INFORMATION MANAGEMENT METHOD AND INFORMATION  
MANAGEMENT APPARATUS  
ART UNIT: 2182; EXAMINER: Not Yet Assigned

RECEIVED  
JUN 14 2001

Technology Center 2100

Assist. Commissioner of Patents  
Washington, D.C. 20231

**REVOCATION AND POWER OF ATTORNEY**

Dear Sir:

SONY CORPORATION, a Japanese Corporation, having a place of business at 7-35, Kitashinagawa 6-chome, Shinagawa-ku, Tokyo 141, Japan and owner of the above-referenced patent application, hereby revokes all former appointments of powers of attorney and hereby appoints the following attorneys to transact all business in the United States

Patent and Trademark Office connected herewith:

Thomas J. Burton, Reg. No. P-47,464  
Brian J. Gill, Reg. No. 46,727  
Gregory Gulliver, Reg. No. 44,138  
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Kevin W. Guynn, Reg. No. 29,927  
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to which all correspondence is to be directed.

The undersigned hereby states that I am empowered to sign this Revocation and Power of Attorney on behalf of SONY CORPORATION and certify that he has reviewed all of the documents in the chain of title in the subject application and to the best of my knowledge and belief, title is in the name of the assignee. The subject assignment is attached.

I hereby declare that all statements made herein of my own knowledge are true, and that all statements made on information and belief are believed to be true; and further, that these statements are made with the knowledge that willful false statements, and the like so made, are punishable by fine or imprisonment, or both, under Section 1001, Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application.

Signature: Yujiro Yamanaka Date: May 30, 2001

Name: Yujiro Yamanaka  
(Print)

Title: Manager, Legal & Intellectual Property Dept.

## ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in INFORMATION MANAGEMENT METHOD AND INFORMATION MANAGEMENT APPARATUS

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 09/695,623, Filing Date: October 24, 2000.

This assignment executed on the dates indicated below.

HIROYUKI HONMA

Name of first or sole inventor

Execution date of U.S. Patent Application

CHIBA, JAPAN

Residence of first or sole inventor

*Hiroyuki Honma*

Signature of first or sole inventor

*February 13, 2001*

Date of this assignment